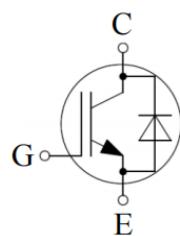


## IGBT Discrete

V <sub>CE</sub>	650	V
I <sub>C</sub>	100	A
V <sub>CE(SAT)</sub> I <sub>C</sub> =100A	1.35	V

### Circuit



### Applications

- General purpose inverters
- Motor drives
- Uninterruptible power supply
- Medium to low switching frequency power converters

### Features

- High speed smooth switching device for hard & soft switching
- Maximum junction temperature 175°C
- Positive temperature coefficient
- High ruggedness, temperature stable

### Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V <sub>CE</sub>	650	V
DC Collector Current, limited by T <sub>jmax</sub> T <sub>C</sub> = 25°C value limited by bondwire T <sub>C</sub> = 100°C	I <sub>C</sub>	160 100	A
Diode Forward Current, limited by T <sub>jmax</sub> T <sub>C</sub> = 25°C value limited by bondwire T <sub>C</sub> = 100°C	I <sub>F</sub>	160 100	A
Continuous Gate-Emitter Voltage	V <sub>GE</sub>	±20	V
Transient Gate-Emitter Voltage (tp≤10μs,D<0.010)	V <sub>GE</sub>	±30	V
Turn off Safe Operating Area V <sub>CE</sub> ≤650V, T <sub>j</sub> ≤ 150°C		400	A
Pulsed Collector Current, V <sub>GE</sub> =15V, tp limited by T <sub>jmax</sub>	I <sub>CM</sub>	400	A
Diode Pulsed Current, tp limited by T <sub>jmax</sub>	I <sub>Fpuls</sub>	400	A
Power Dissipation , T <sub>j</sub> =175°C, T <sub>C</sub> =25°C	P <sub>tot</sub>	428	W



Operating Junction Temperature	T <sub>j</sub>	-40...+175	°C
Storage Temperature	T <sub>s</sub>	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

**Electrical Characteristics of the IGBT (T<sub>j</sub>= 25°C unless otherwise specified):**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Collector-Emitter Breakdown Voltage	BV <sub>CES</sub>	V <sub>GE</sub> =0V, I <sub>C</sub> =250μA	650		-	V
Gate Threshold Voltage	V <sub>GE(th)</sub>	V <sub>GE</sub> =V <sub>CE</sub> , I <sub>C</sub> =1.20mA	3.25	3.75	4.25	V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> =15V, I <sub>C</sub> =100A T <sub>j</sub> =25°C, T <sub>j</sub> =125°C T <sub>j</sub> =150°C	1.00	1.35 1.50 1.55	1.70	V
Zero Gate Voltage Collector Current	I <sub>CES</sub>	V <sub>CE</sub> =650V, V <sub>GE</sub> =0V T <sub>j</sub> = 25°C, T <sub>j</sub> =150°C			0.25 3.00	mA
Gate-Emitter Leakage Current	I <sub>GES</sub>	V <sub>CE</sub> = 0V, V <sub>GE</sub> = ± 20V			200	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic</b>						
Input Capacitance	C <sub>ies</sub>	V <sub>CE</sub> = 25V, V <sub>GE</sub> = 0V, f = 1MHz	-	4.96	-	nF
Reverse Transfer Capacitance	C <sub>res</sub>		-	0.05	-	
Gate Charge	Q <sub>G</sub>	V <sub>CC</sub> =300V, I <sub>C</sub> =100A, V <sub>GE</sub> =-5V~+15V	-	0.34	-	uC

Electrical Characteristics of the Diode ( $T_j = 25^\circ\text{C}$  unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Diode Forward Voltage	$V_F$	$I_F = 100\text{A}$ $T_j = 25^\circ\text{C}$ , $T_j = 125^\circ\text{C}$ $T_j = 150^\circ\text{C}$		1.40 1.35 1.30	1.90	V

## Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic , at <math>T_j = 25^\circ\text{C}</math></b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 300\text{V}$ , $I_C = 100\text{A}$ , $V_{GE} = -5\text{v} \sim 15\text{V}$ , $R_g = 10\Omega$ Inductive Load	-	19	-	ns
Rise Time	$t_r$		-	95	-	ns
Turn-on Energy	$E_{on}$		-	4.0	-	mJ
Turn-off Delay Time	$t_{d(off)}$		-	204	-	ns
Fall Time	$t_f$		-	44	-	ns
Turn-off Energy	$E_{off}$		-	1.1	-	mJ
Total switching energy	$E_{ts}$		-	5.1	-	mJ
<b>Dynamic , at <math>T_j = 125^\circ\text{C}</math></b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 300\text{V}$ , $I_C = 100\text{A}$ , $V_{GE} = -5\text{v} \sim 15\text{V}$ , $R_g = 10\Omega$ Inductive Load	-	22	-	ns
Rise Time	$t_r$		-	88	-	ns
Turn-on Energy	$E_{on}$		-	4.1	-	mJ
Turn-off Delay Time	$t_{d(off)}$		-	220	-	ns
Fall Time	$t_f$		-	55	-	ns
Turn-off Energy	$E_{off}$		-	1.4	-	mJ
Total switching energy	$E_{ts}$		-	5.5	-	mJ
<b>Dynamic , at <math>T_j = 150^\circ\text{C}</math></b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 300\text{V}$ , $I_C = 100\text{A}$ , $V_{GE} = -5\text{v} \sim 15\text{V}$ , $R_g = 10\Omega$ Inductive Load	-	23	-	ns
Rise Time	$t_r$		-	84	-	ns
Turn-on Energy	$E_{on}$		-	4.2	-	mJ
Turn-off Delay Time	$t_{d(off)}$		-	226	-	ns
Fall Time	$t_f$		-	59	-	ns
Turn-off Energy	$E_{off}$		-	1.6	-	mJ
Total switching energy	$E_{ts}$		-	5.8	-	mJ

**Electrical Characteristics of the DIODE**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic , at T<sub>j</sub>= 25°C</b>						
Reverse Recovery Current	I <sub>rr</sub>	I <sub>F</sub> =100A, V <sub>R</sub> =300V -di/dt=550A/μs,	-	23	-	A
Reverse Recovery Charge	Q <sub>rr</sub>		-	1.8	-	uC
Diode reverse recovery time	trr		-	116	-	ns
Reverse Recovery Energy	Erec		-	0.16	-	mJ
<b>Dynamic , at T<sub>j</sub>= 125°C</b>						
Reverse Recovery Current	I <sub>rr</sub>	I <sub>F</sub> =100A, V <sub>R</sub> =300V -di/dt=550A/μs,	-	36	-	A
Reverse Recovery Charge	Q <sub>rr</sub>		-	4.2	-	uC
Diode reverse recovery time	trr		-	158	-	ns
Reverse Recovery Energy	Erec		-	0.47	-	mJ
<b>Dynamic , at T<sub>j</sub>= 150°C</b>						
Reverse Recovery Current	I <sub>rr</sub>	I <sub>F</sub> =100A, V <sub>R</sub> =300V -di/dt=550A/μs,	-	41	-	A
Reverse Recovery Charge	Q <sub>rr</sub>		-	5.7	-	uC
Diode reverse recovery time	trr		-	197	-	ns
Reverse Recovery Energy	Erec		-	0.61	-	mJ

**Thermal Resistance**

Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	R <sub>th(j-c)</sub>	0.35	K/W
Diode Thermal Resistance, Junction - Case	R <sub>th(j-c)</sub>	0.45	K/W
Thermal Resistance, Junction - Ambient	R <sub>th(j-a)</sub>	40	K/W

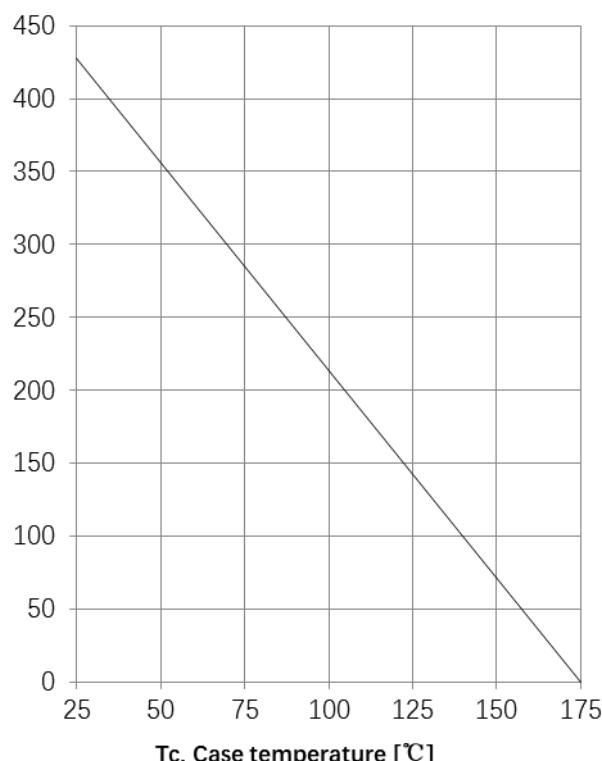


Fig1. Power dissipation as a function of case temperature ( $T_j \leq 175^\circ\text{C}$ )

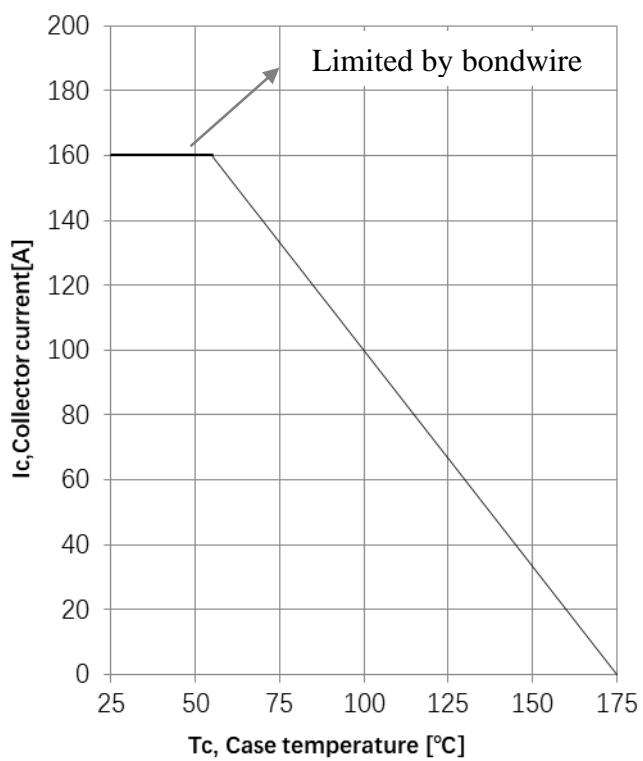


Fig2. Collector current as a function of case temperature ( $V_{ge} \geq 15\text{V}$ ,  $T_j \leq 175^\circ\text{C}$ )

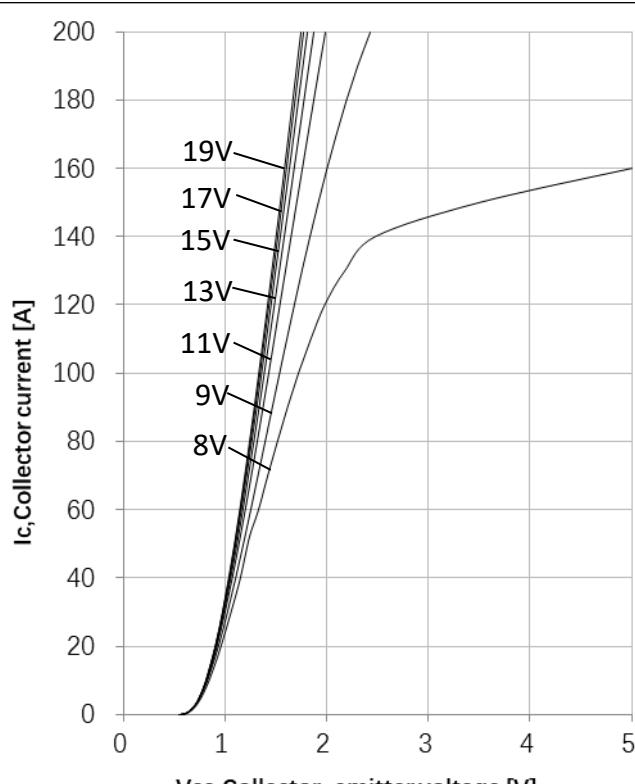


Fig3. Typical output characteristic ( $T_j=25^\circ\text{C}$ )

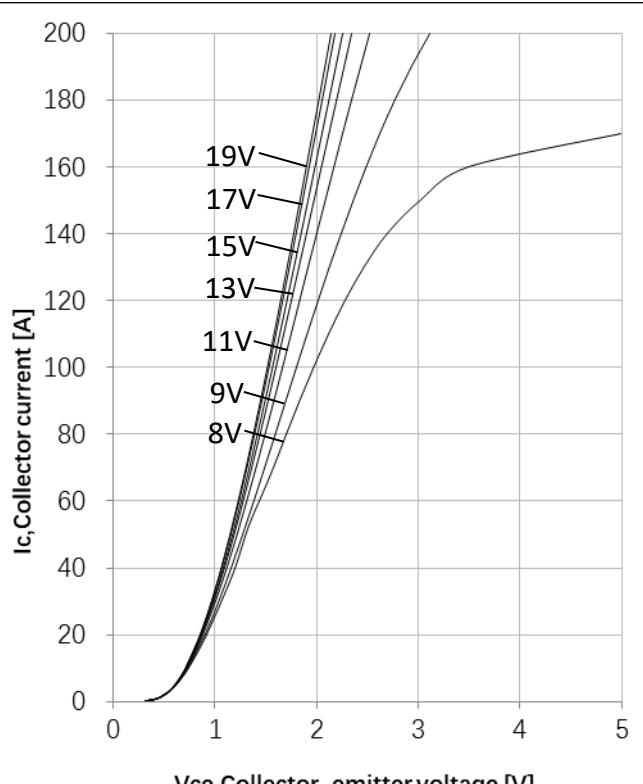


Fig4. Typical output characteristic ( $T_j=150^\circ\text{C}$ )

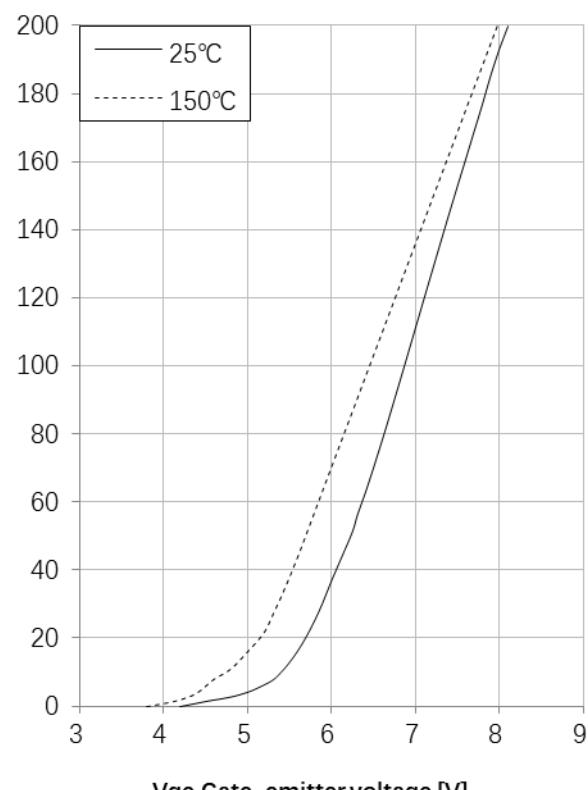


Fig5. Typical transfer characteristic ( $V_{ce}=20V$ )

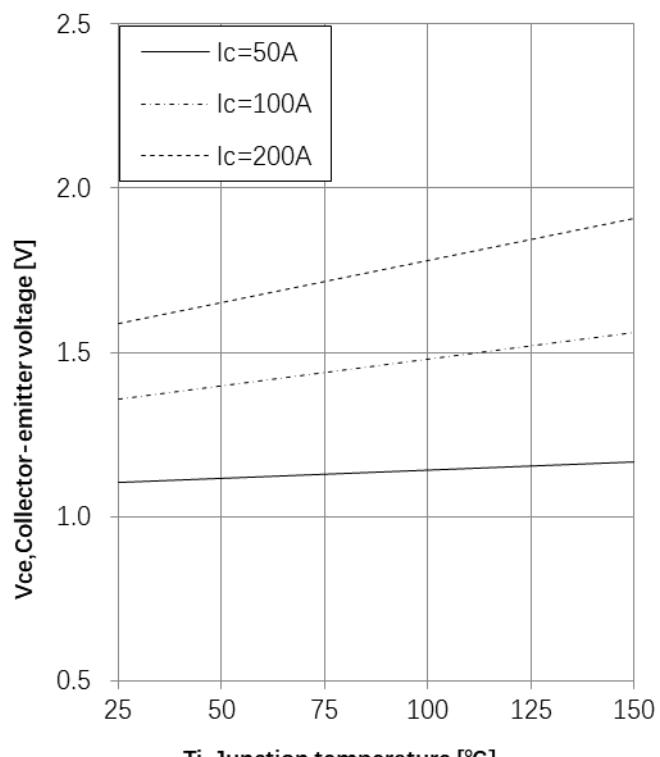


Fig6. Typical collector-emitter saturation voltage as a function of junction temperature( $V_{ge}=15V$ )

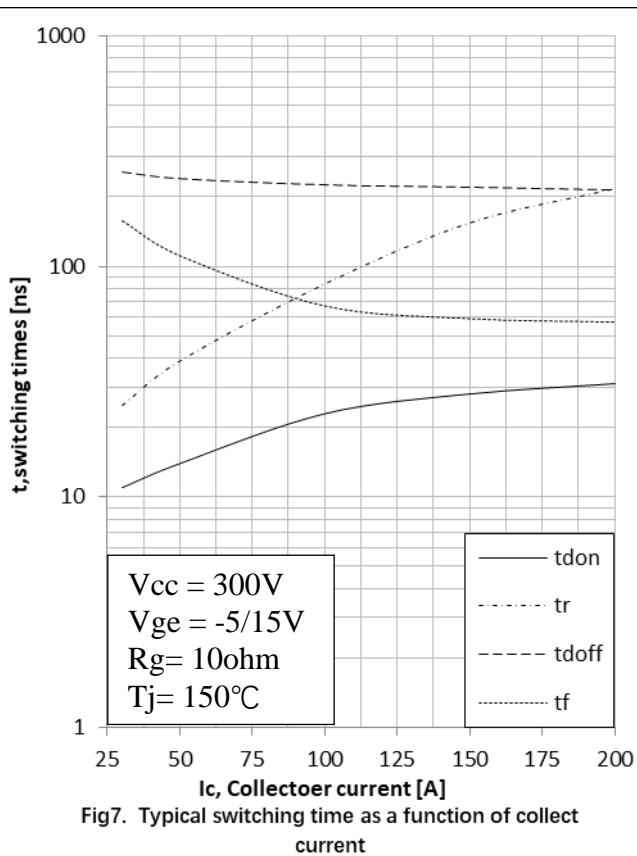


Fig7. Typical switching time as a function of collect current

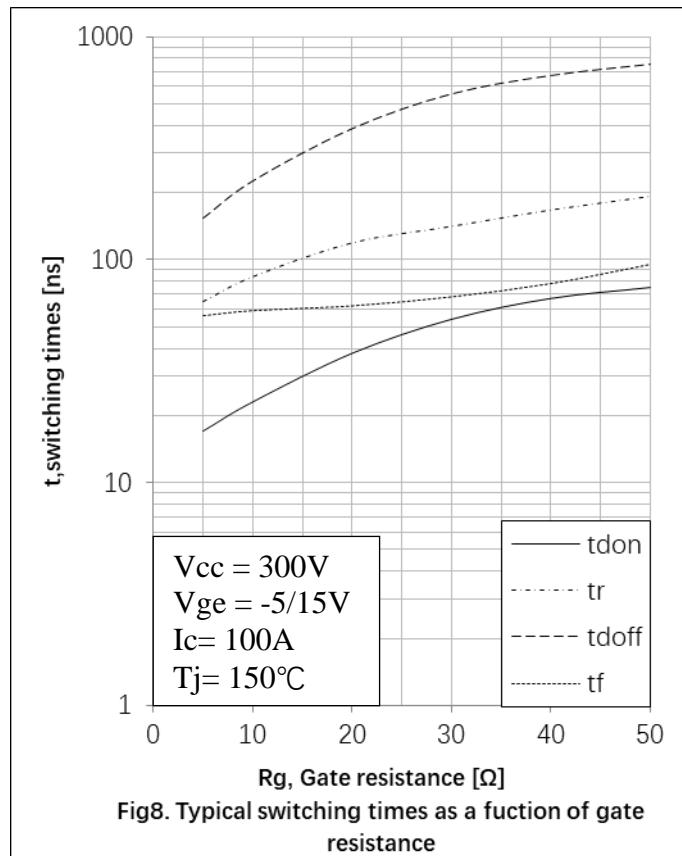
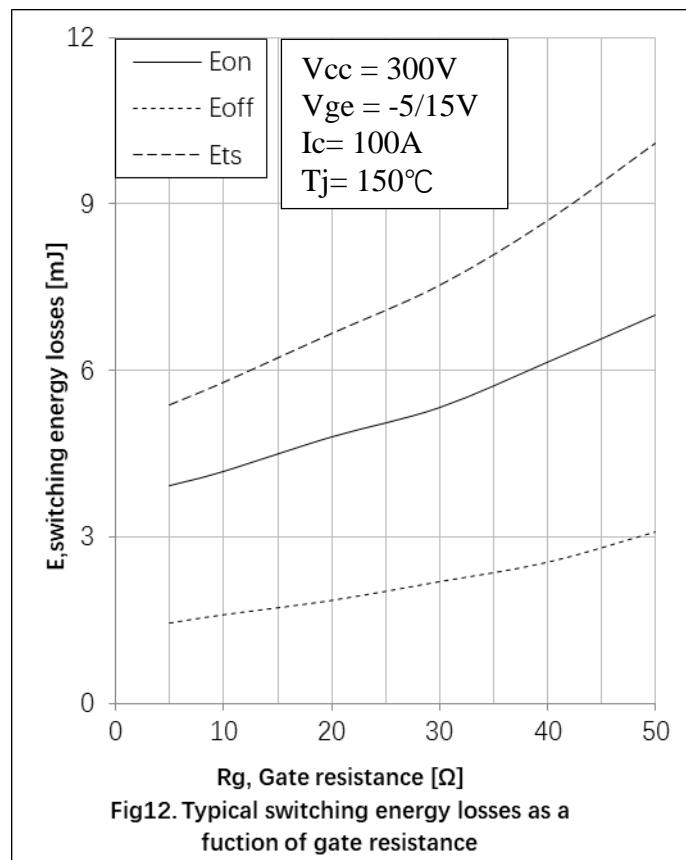
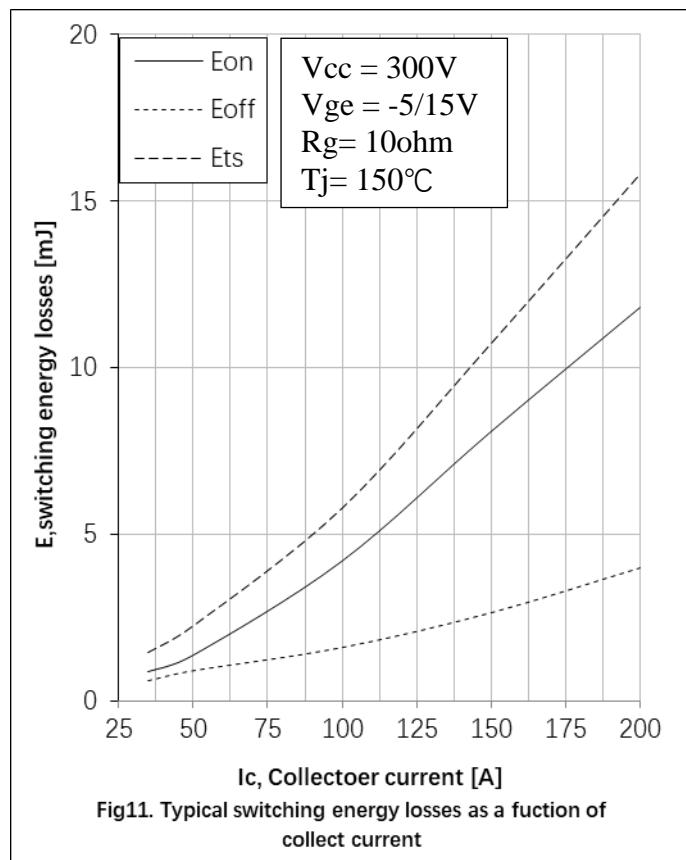
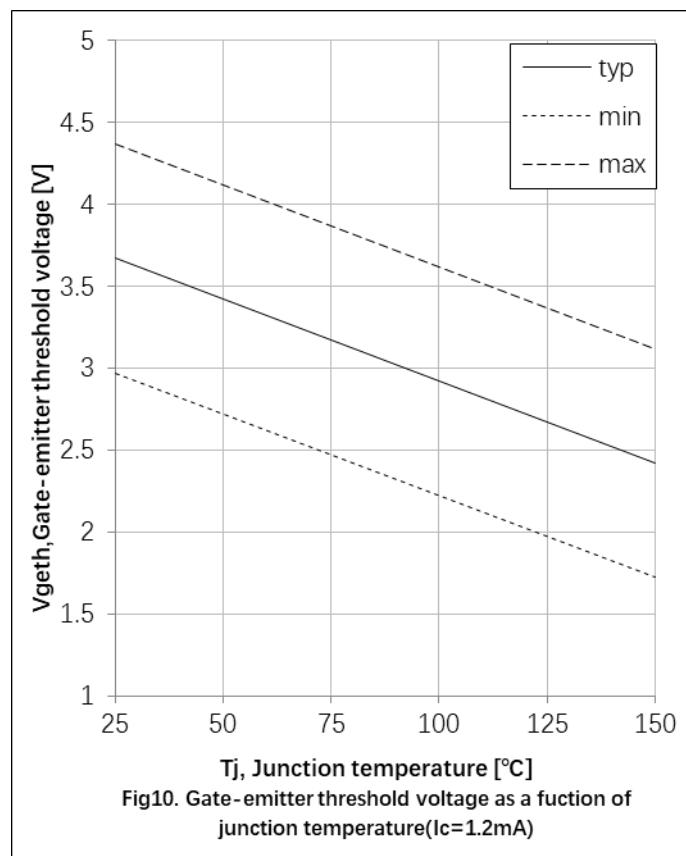
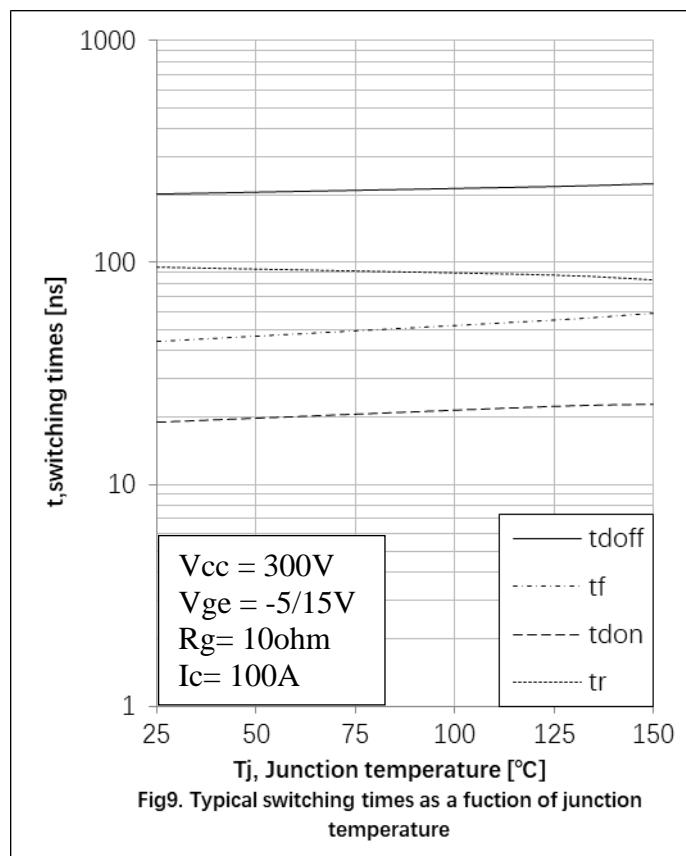
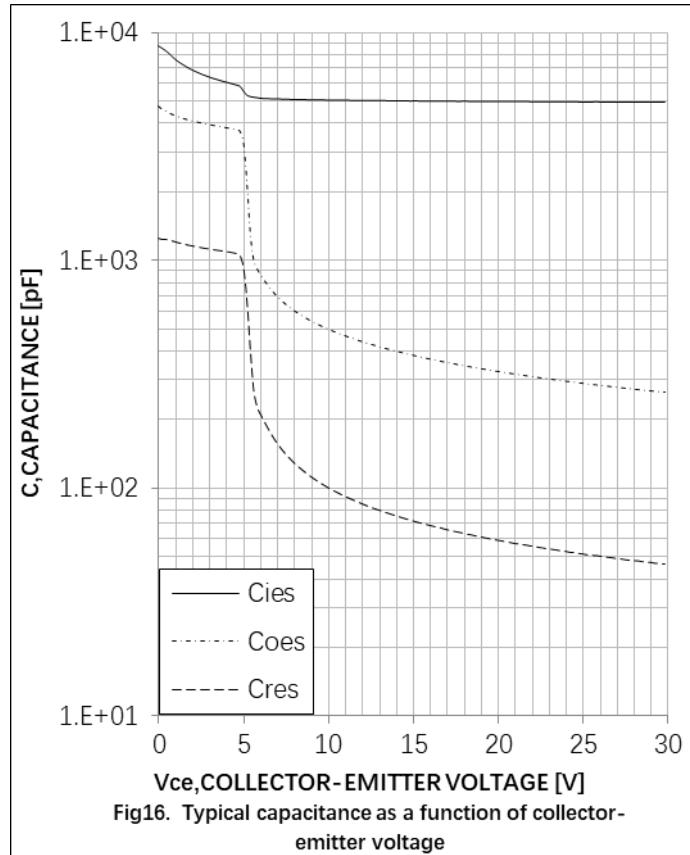
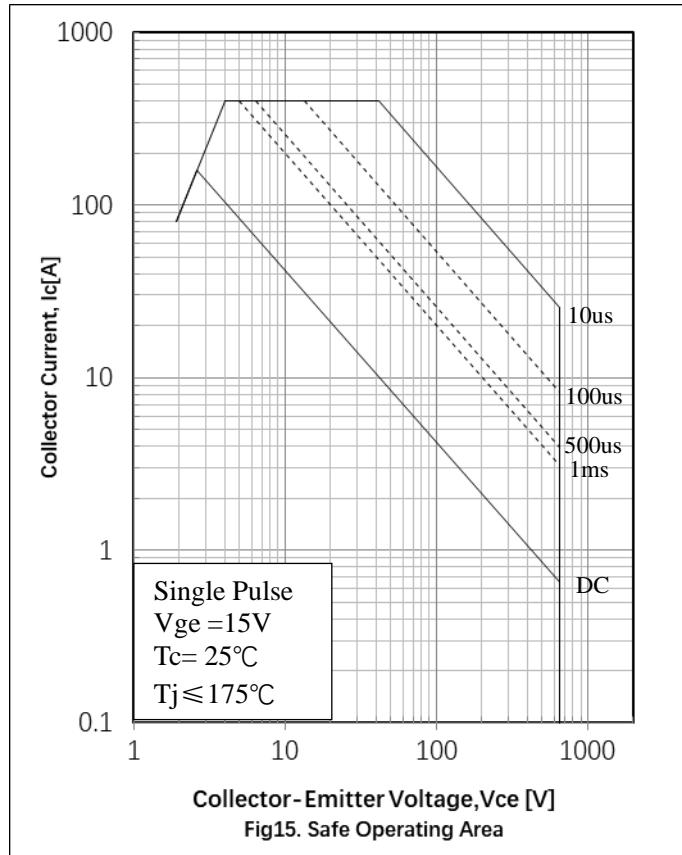
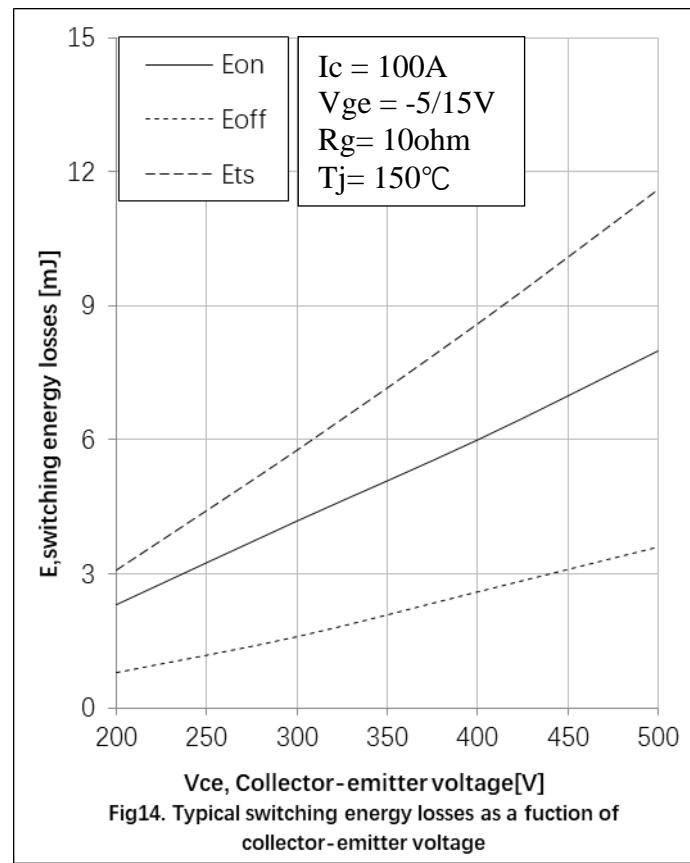
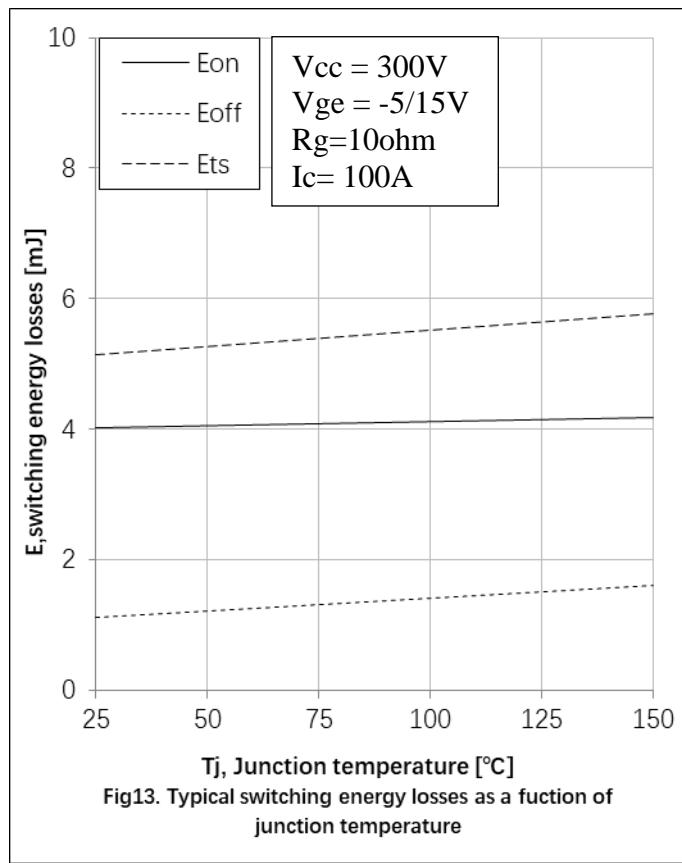
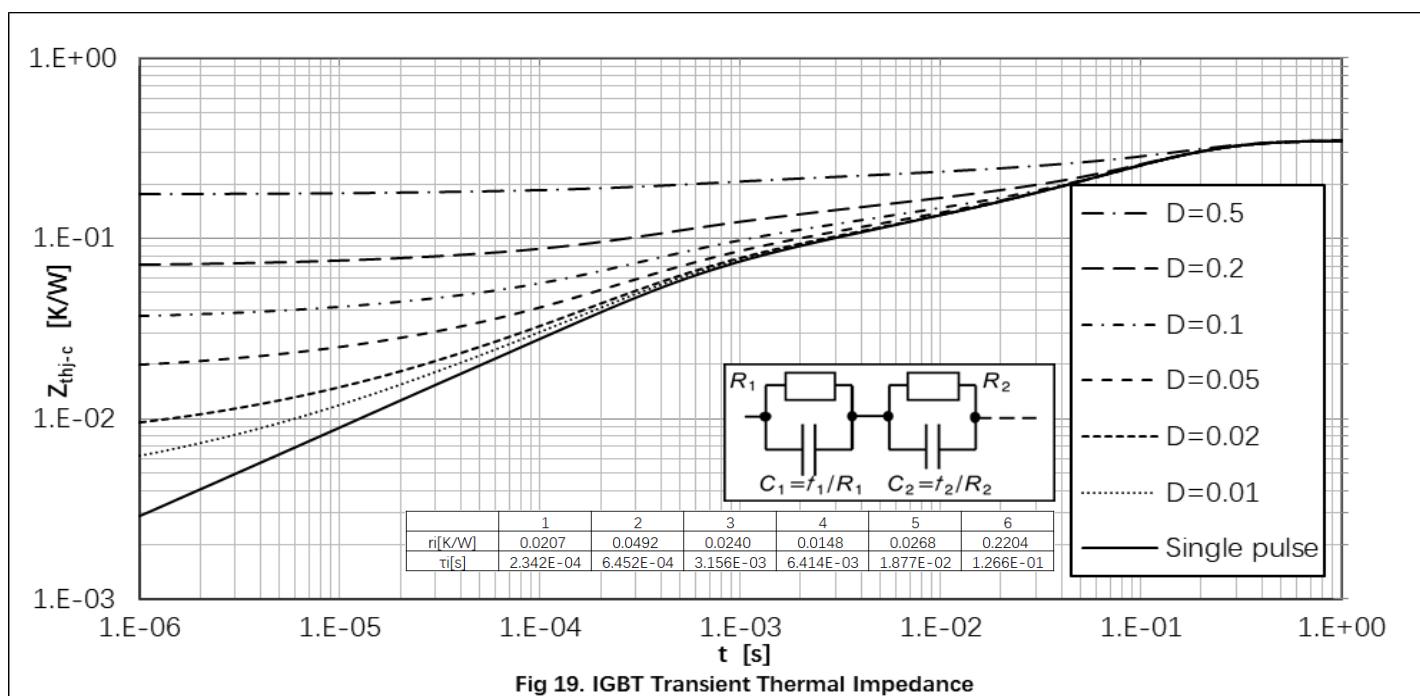
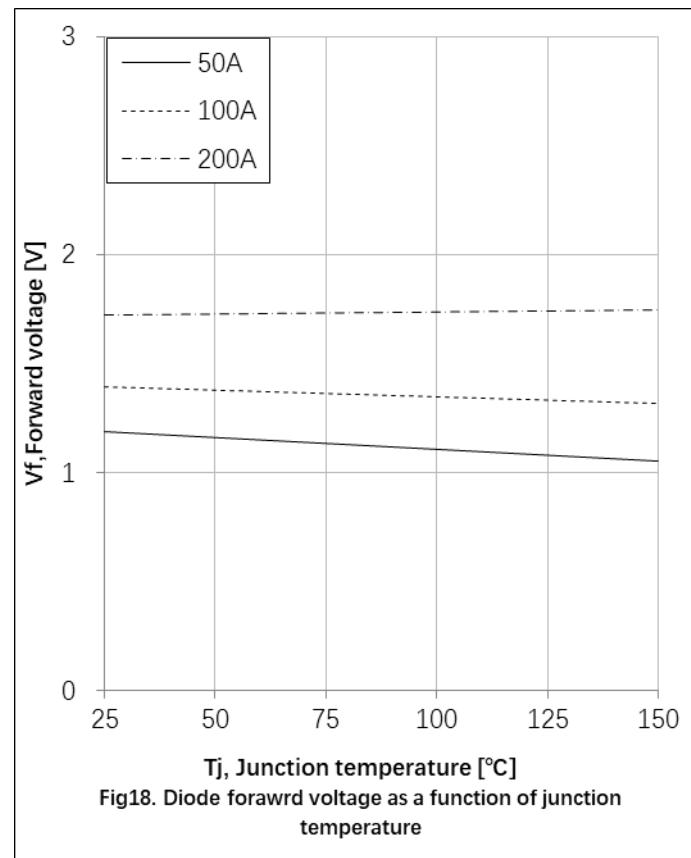
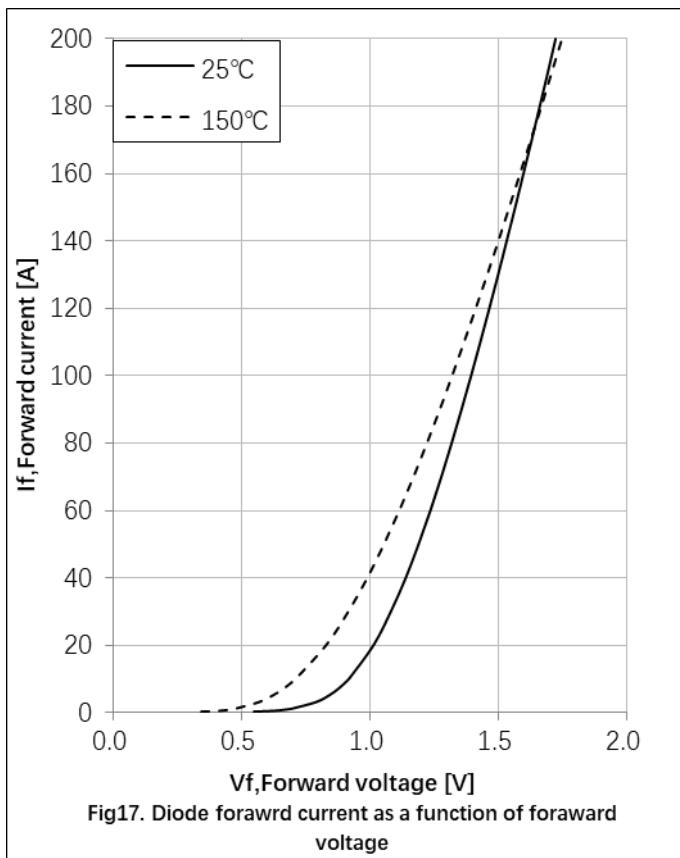
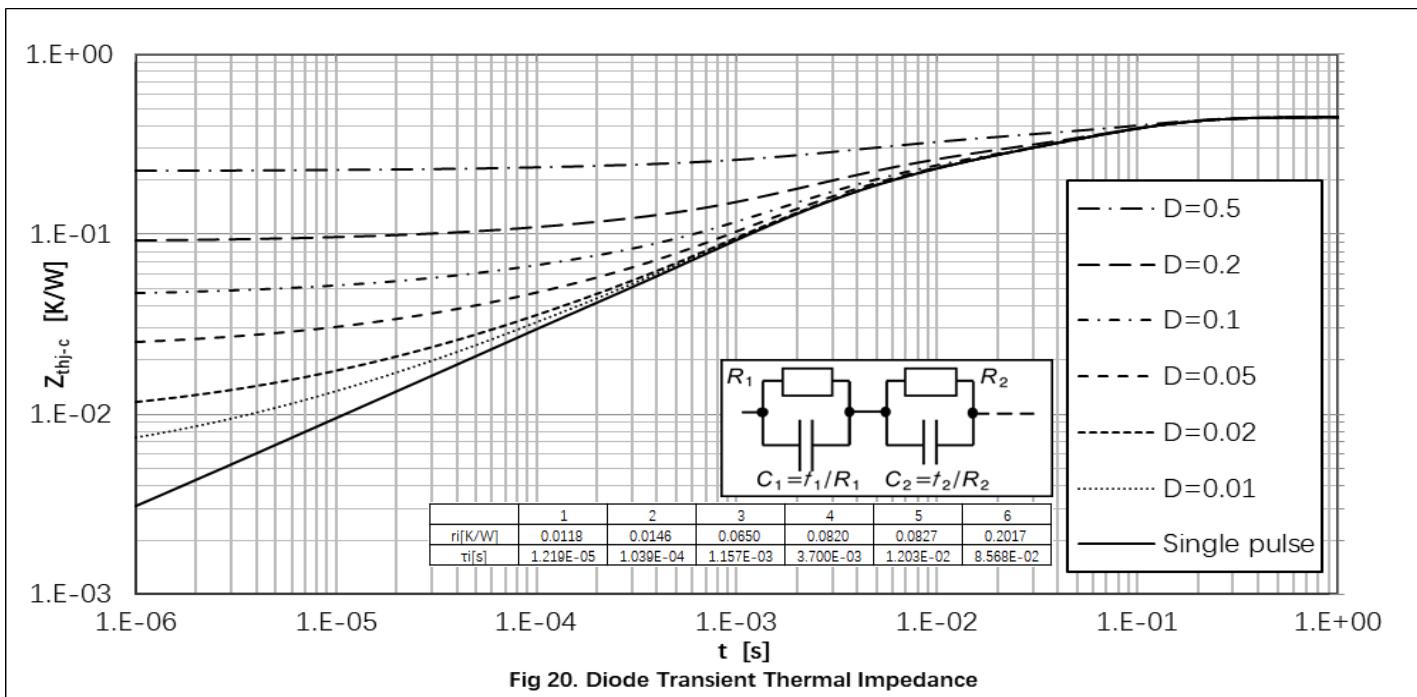


Fig8. Typical switching times as a fuction of gate resistance



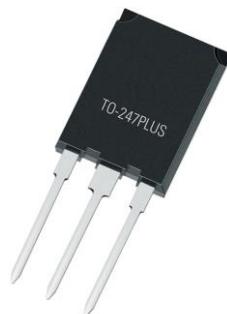
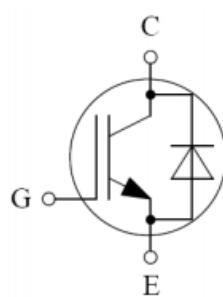






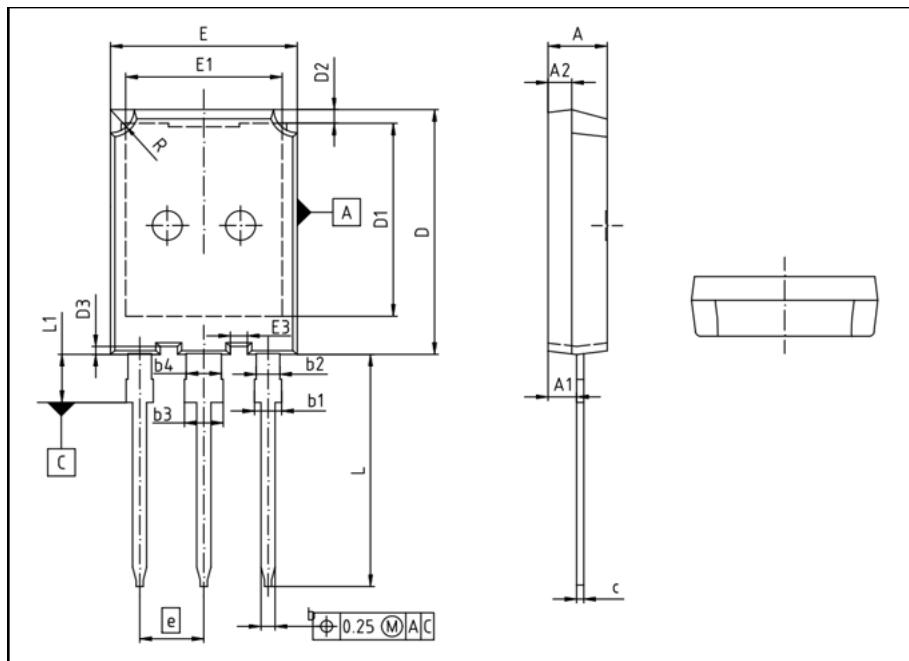


## Circuit Diagram



## ● Package Outline Information

## CASE: TO 247plus



DIM	MILLIMETERS	
	MIN	MAX
A	4.90	5.10
A1	2.31	2.51
A2	1.90	2.10
b	1.16	1.26
b1	1.86	2.16
b2	1.96	2.06
c	0.58	0.64
D	20.90	21.10
D1	16.25	16.85
D2	1.05	1.35
D3	0.58	0.78
E	15.70	15.90
E1	13.10	13.50
E3	1.35	1.55
e	5.44(BSC)	
L	19.78	20.08
L1	4.03	4.23
R	1.90	2.10